

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Fuminobu HIROSE</td><td>04/24/2008</td></tr><tr><td>Toshio MIYAGAWA</td><td>04/24/2008</td></tr><tr><td>Kenichi SENDA</td><td>04/24/2008</td></tr></tbody></table>	Name	Execution Date	Fuminobu HIROSE	04/24/2008	Toshio MIYAGAWA	04/24/2008	Kenichi SENDA	04/24/2008	
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Fuminobu HIROSE	04/24/2008								
Toshio MIYAGAWA	04/24/2008								
Kenichi SENDA	04/24/2008								
RECEIVING PARTY DATA									
Name:	Kaneka Corporation								
Street Address:	2-4, Nakanoshima 3-chome, Kita-ku								
City:	Osaka-shi, Osaka								
State/Country:	JAPAN								
Postal Code:	530-8288								
PROPERTY NUMBERS Total: 1									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11909717</td></tr></tbody></table>	Property Type	Number	Application Number:	11909717					
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Application Number:	11909717								
CORRESPONDENCE DATA									
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NAME OF SUBMITTER:	Sheldon I. Landsman								
Total Attachments: 1 source=ASSIGNMENT#page1.tif									

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PATENT

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REEL: 021357 FRAME: 0177

Assignment

Whereas, I/We, Fuminobu HIROSE, c/o Kaneka Corporation Osaka Plant, 1-1, Torikainishi, Settsu-shi, Osaka 566-0072, Japan; Toshio MIYAGAWA, c/o Kaneka Corporation Osaka Plant, 1-1, Torikainishi, Settsu-shi, Osaka 566-0072, Japan; and Kenichi SENDA, c/o Kaneka Corporation Osaka Plant, 1-1, Torikainishi, Settsu-shi, Osaka 566-0072, Japan, respectively, hereinafter called assignor(s), have invented certain improvements in FOAMED THERMOPLASTIC RESIN PARTICLES AND METHOD OF PRODUCING THE FOAMED PARTICLES and executed an application for Letters Patent of the United States of America therefor on _____; and

Whereas, KANEKA CORPORATION, 2-4, Nakanoshima 3-chome, Kita-ku, Osaka-shi, Osaka, 530-8288, Japan (assignee), 1 Procter & Gamble Plaza, Cincinnati, OH 45202, U.S.A. (assignee), desire to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee(s), its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including the right to claim priority under 35 U.S.C. §119, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee(s), its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee(s) in connection with the United States application when called upon to do so by the assignee(s).

I/We hereby authorize and request our attorneys SUGHRUE MION, PLLC of 2100 Pennsylvania Avenue, NW, Washington, DC 20037-3213 to insert here in parentheses (Application number _____ and Confirmation number _____, filed _____) the application number and filing date of said application when known.

Date: 2008/4/24

廣瀬 文信

s/Fuminobu HIROSE

Date: 2008/4/24

宮川 登元

s/Toshio MIYAGAWA

Date: 2008/4/24

千田 健一

s/Kenichi SENDA

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. §261)